

Electronic Acknowledgement Receipt

EFS ID:	1080816
Application Number:	10791896
Confirmation Number:	4798
Title of Invention:	Semiconductor chip package and method for manufacturing the same
First Named Inventor:	Su Tao
Customer Number:	22429
Filer:	Benjamin J. Hauptman/Ayesha Wilson
Filer Authorized By:	Benjamin J. Hauptman
Attorney Docket Number:	4459-140
Receipt Date:	15-JUN-2006
Filing Date:	04-MAR-2004
Time Stamp:	18:50:24
Application Type:	Utility
International Application Number:	

Payment information:

Submitted with Payment	no
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1	Amendment - After Non-Final Rejection	20060615Amendment.pdf	265071	no	8

Warnings:		
Information:		
	Total Files Size (in bytes):	265071
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<p>New Applications Under 35 U.S.C. 111 If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.</p>		
<p>National Stage of an International Application under 35 U.S.C. 371 If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.</p>		